1	2	}	4	5	6	7	8
			1				
ARTING DIN DOWER	male connector –	SML		Soldering instr	UCTIONS		
				SMC (Surface	Mount Compatible) connectors are desir	gned to be used in a reflow oven toge	other with other SMD (Surface Mount
				Device) compon			
eneral information	· · · ·					Reflow", the connectors are inserted	into plated through holes in a
	· · · · ·	:	<u>.</u>		y to conventional Inting. All other components can be as	sembled on the orb surface	
esign	IEC 60603-2	types: D, E male			anning. All officer components can be as		
of contacts	max. 48					h that they protrude by no more than	1.5 millimetres after insertion to th
ntact spacing	5,08 mm	(2,54 mm or 5,08 mm	n on termination side for type E a	ngled) pcb. Each conta		in the hole. So if the contact is too lo	and this colder would be longer be
st voltage	1550V			to reflow back			ing, this solder would no longer be a
tact resistance	max. 15m0hm			plated through	hole by capillary action during the sc	oldering process, therefore the quality	of the soldered connection would
llation resistance	min. 10120hm			suffer as a re	esult.		
rking current	max. 6 A at 20°C (see derating diagra	m)					
perature range	-55°C +125°C			Quantity of so	lder paste		
	max. 15s at 240°C for reflow soldering						
mination technology	SMC (Surface Mount Compatible) with s				onents are assembled, solder paste must be	e applied to all the solder pads (for connect	ing surface-mount components) and the p
rance	min. 3,0 mm	(min. 1,6 mm for 2,54	4 mm contact spacing at type E ar				
epage	min. 3,0 mm				he plated through holes are completely till re numerous calculation methods available w	ed, significantly more solder paste must be which are complicated to apply	applied than traditional solder pads on t
nsertion and withdrawal force	32pol. max. 50N				le of thumb has proved valuable in practice:		
	48pol. max. 75N						
lating cycles	- PL1 acc. to IEC 60 603-2 =>	500 mating cycles		VPaste = 2(VH -	VP)		
	- PL2 acc. to IEC 60 603-2 =>	400 mating cycles		in which: VPaste = Require	ed volume of solder paste		
	- PL3 acc. to IEC 60 603-2 =>	50 mating cycles			the plated through hole		
ile	E102079				the connector termination in the hole		
S – compliant	Yes					Later and the coldestand For Mithematica	
dfree	Yes			Lomment: the mut of the actual so	Itiplier "2" compensates for solder paste st Ider, the other 50 % being soldering aids.	hrinkage during soldering. For this purpose,	if was assumed that 50 % of the paste
plugging	No				tuer, me omer 50 % being sotuering alus.		
				Cross section	of solder nins		
ılator material							
erial	PCT (thermoplastics, glass fiber reinforcement 30%)			025			
ur	natural-colored, color deviations and	speckles permitted		0,6_0,025	0,29 - 0,33 mm ²		
classification	UL 94-V0			0,6			
erial group acc. to IEC 60664-1	II (400 <u><</u> CTI < 600)						
classification	13, F3				0,5 ^{+0,05}		
					0,5		
act material							
act material	Copper alloy						
ing termination zone	Sn over Ni						
ing contact zone	Au over PdNi over Ni						
ating diagram acc. to IEC 60512-5 (Cu	rrent carrying capacity)						
current carrying capacity is limited t		٨					
perature of materials for inserts and							
ninals.	-	5					
The current capacity curve is valid for continuous, non					All Dimensions in mm Scale Free size	e tol	Ref.
interrupted current loaded contacts of connectors when simultaneous power on all contacts is given, without exceeding					All Dimensions in mm Scale Free Size Original Size DIN A3 1:1		Sub. DS 09 04 103 02 01 / EC01557 / 28.04.2011
the maximum temperature.						Inspected by Standardisation	Date State
				HAGEMEYERE		2014-08-11 Final Release	
	ontrol and test procedures according to DIN IEC 60512-5						2014-00-11 Fillal Release Doc-Key / E
trol and test procedures according to		iii 1 + - + - + - + - + - + - + - + - + - +				male connector CMC	DUL-NEY / E 100E00E12/UG
trol and test procedures according to						IIIdle folligerini - Sun	1002002151001
trol and test procedures according to				HARTING Electronic		male connector - SMC	
trol and test procedures according to		0 20 40	60 80 100 120 °C Temperature [°C]	HARTING Electronic D-32339 Espelkamp		^{mber} 09041030201	100580512/UGC 50000076067 Rev. A